DATE: 27, October, 2021

Dear Shri Nivas.

Budhana Tech, LLP is pleased to offer you a job as a **Software Engineer**. We trust that your knowledge, skills will be among our most valuable assets. Following are a few terms of your appointment.

- **Probation Period**: Four months.
- **Remuneration**: Rs.15000 by NEFT for probation period.
- Leave Policy: You are not entitled to take any leave during your probation period.
- Office time: We work from flexi timing Monday to Saturday. Also, we remain closed on every First, Third and Fifth Saturday.
- **HR Policy**: You'll have to follow all rules & regulations of the company during your tenure. In case of any mischief or dispute company is liable to take any action against you.
- Compensation Revision: Your salary will be revised after probation, subject to performance
- **Notice Period:** You'll have to provide the notice period of working 30 days, if you plan to leave the job.



To accept this job, offer:

- 1. Reply back to undersigned by email for your confirmation of the job offer, no later than 28, October, 2021.
- 2. Sign and date this job offer letter where indicated below and reply back a scanned copy of the letter via email.
- 3. Please Provide the photocopy of the following along with the above Job letter as attachment in the same email.
 - Last Semester mark sheet for which you appeared in exam,
 - o Any two photo ID proof,
 - o Two passport size photos,

We at Budhan Tech, LLP hopes that you'll accept this job offer and looks forward to welcoming you aboard.

Your Immediate Supervisor will be Mr. Preet Singh

Sincerely,

Maheshkumar Mishra,

Business Analyst, HR Admin

MAHESHKU Digitally signed by

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MAHESHKUMAR

LAXMINARAYAN

LAXMINARA MISHRA

Date: 2021.10.27

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Accept job Offer:

By signing and dating this letter below, I, Shri Nivas, accept this job offer of project Trainee at Budhana Tech, LLP. I am expected to join our company on October 29, 2021 (Reporting Time: 10:00 AM) for further joining formalities.

Signature:

Date: 77/10/2021